

Product Data Sheet Type: IS561

Group: ACCESSORIES Thermal Interface Material

Insulation bushings

Temperature resistance :	200 °C
Electrical insulating :	16 kV
Thickness :	0,2
Inner diameter :	3.1
Outer diameter :	3.5
Diameter :	6
For device :	TO220 TO218 (TOP3) Multi
Device mounted by :	Screw
Material :	SR25



Insulating bushes in combination with insulating wafers from mica or silicone foil facilitate insulated mounting of semiconductors to heatsinks or other components.

Combustibility: According to UL 94 VO

Material: SR25

Compound: Polysulfone

Dielectric strength: 16 KV/mm

Heat resistance: 200 °C

For cases: TO220/TOP3 (TO218)

